MP2639C



2-Cell Li-lon or Li-Polymer Switching Charger Compatible with 5V Input and Integrated, Bidirectional Charge/Discharge with Cell Balance

DESCRIPTION

The MP2639C is a highly integrated, flexible, switch-mode, battery-charging management device for 2-cell series Li-ion and Li-polymer batteries used in a wide range of portable applications.

The MP2639C is able to charge a 2-cell battery from a 5V adapter or USB input. The MP2639C can work in three modes: charge mode, discharge mode, and sleep mode.

In 2-cell applications, the 5V input charges the 2-cell battery via the MP2639C operating in step-up mode. When the 5V input is absent, the 2-cell battery voltage is discharged to the 5V output via the MP2639C working in step-down mode.

For the charging function, the MP2639C detects the battery voltage automatically and charges the battery in three phases: trickle current, constant current, and constant voltage. Other features include charge termination and autorecharge.

To guarantee safe operation, the MP2639C limits the die temperature to a preset value of 120°C. Other safety features include input overvoltage protection (OVP), battery over-voltage protection (OVP), thermal shutdown, battery temperature monitoring, and a programmable timer to prevent prolonged charging of a dead battery.

The MP2639C is available in a QFN-26 (4mmx4mm) package.

FEATURES

- 4.0V to 5.75V Input Voltage Range
- Charge 2-Cell Batteries with 5V Input
- USB-Compliant Charger
- Integrates Input Current-Based and Input Voltage-Based Power Management Functions
- Programmable Input Current and Input Voltage Limit
- Up to 2.5A Programmable Charge Current for 2-Cell Applications
- 8.4V Charge Voltage with 0.5% Accuracy
- Up to 5.0A Programmable Discharge Current
- Negative Temperature Coefficient Pin for Temperature Monitoring
- No Load Shutdown and Push Button Turn-On in Discharge Mode
- Programmable Timer Back-Up Protection
- Discharge Mode Load Trace Compensation
- Thermal Regulation and Thermal Shutdown
- Internal Battery Reverse Leakage Blocking
- Integrated Short-Circuit Protection (SCP) for Both Charge and Discharge Mode
- Four LED Battery Level and Status Indicators
- Available in a QFN-26 (4mmx4mm) Package

APPLICATIONS

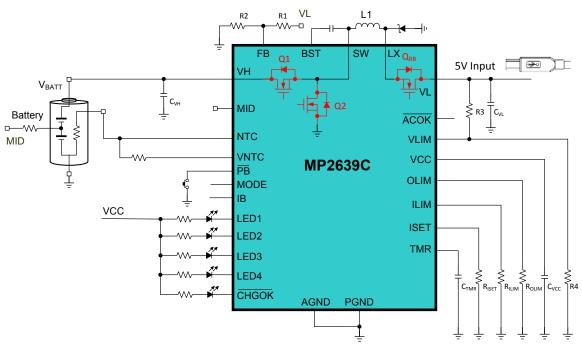
- Power Station Applications
- Power Bank Applications for Smart Phones, Tablets, and Other Portable Devices
- Mobile Internet Devices

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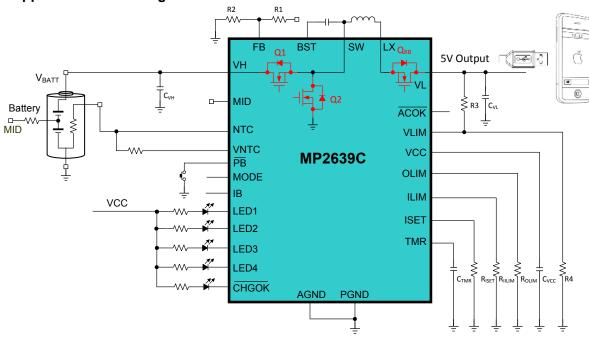


TYPICAL APPLICATION

2-Cell Application - Charge Mode



2-Cell Application - Discharge Mode



Adapter Term	BATT Term	MODE	CHG/DSG	Active SW	Topology
VL VH	High	DSG	Q1	Step-down	
	VH	VH	Low	CHG	Q2



ORDERING INFORMATION

Part Number*	Package	Top Marking	
MP2639CGR	QFN-26 (4mmx4mm)	See Below	

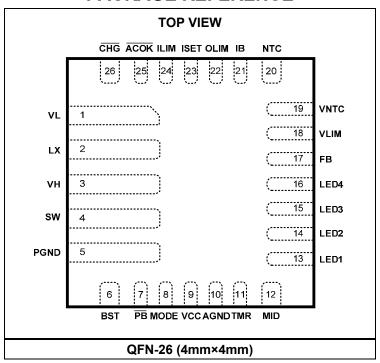
^{*} For Tape & Reel, add suffix -Z (e.g.: MP2639CGR-Z).

TOP MARKING

MPSYWW M2639C LLLLLL

MPS: MPS prefix Y: Year code WW: Week code M2639C: part number LLLLL: Lot number

PACKAGE REFERENCE



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PIN FUNCTIONS

Package Pin #	Name	Description
1	VL	Low-voltage terminal. Attach a 5V input to VL.
2	LX	Connection node between the induction and internal block switch.
3	VH	High-voltage terminal. Attach a 2-cell battery to VH.
4	SW	Switching node.
5	PGND	Power ground. Connect the exposed pad and GND to the same ground plane.
6	BST	Bootstrap. Connect a 100 - 500nF BST capacitor between the BST and SW node.
7	PB	Push button input. Connect a push button from PB to AGND pulled up internally by a resistor. When PB is pushed for less than 2.5s, the discharge function is enabled and latched when MODE is high. If discharging is enabled, push PB for more than 2.5s to disable the discharge. Otherwise, discharging remains, and LED1-4 are enabled for 5s.
8	MODE	Charge or discharge mode selection. Pull MODE to low logic to make the MP2639C work in charge mode. Pull MODE to logic high to make the MP2639C work in discharge mode.
9	VCC	Internal circuit power supply. Bypass VCC to AGND with a 1μF ceramic capacitor. VCC cannot float or carry an external load higher than 50mA.
10	AGND	Analog ground.
11	TMR	Oscillator period timer. Connect a timing capacitor between TMR and AGND to set the oscillator period. Short TMR to AGND to disable the timer function.
12	MID	Middle point of the 2-cell battery. MID is used to detect the voltage of each cell in a 2-cell application. Connect MID to GND if it is not being used.
13	LED1	Fuel gauge indication. LED1 works with LED2, LED3, and LED4 to achieve the voltage-based fuel gauge.
14	LED2	Fuel gauge indication. LED2 works with LED1, LED3, and LED4 to achieve the voltage-based fuel gauge.
15	LED3	Fuel gauge indication. LED3 works with LED1, LED2, and LED4 to achieve the voltage-based fuel gauge.
16	LED4	Fuel gauge indication. LED4 works with LED1, LED2, and LED3 to achieve the voltage-based fuel gauge.
17	FB	Voltage feedback input in discharge mode.
18	VLIM	Input voltage limit setting in charge mode.
19	VNTC	Pull-up bias voltage of both the NTC resistive dividers. VNTC is connected to VCC by an internal switch, which is turned on only in charge mode. Do not connect any capacitors to VNTC.
20	NTC	Negative temperature coefficient (NTC) thermistor.
21	IB	Current output for the battery current monitor. IB is proportional to the real battery current. Connect an R-C filter from IB to AGND.
22	OLIM	Discharge output current limit setting. Connect an external resistor from OLIM to AGND to program the system current.
23	ISET	Charge current set. Connect an external resistor from ISET to AGND to program the charge current.
24	ILIM	Input current limit setting in charge mode.
25	ACOK	Valid input supply indicator. ACOK is an open-drain output. ACOK is pulled low when the input voltage is recognized as a good source.
26	CHG	Charging completion indicator. CHG at logic low indicates charge mode. CHG becomes an open drain once the charging has completed or is suspended.



ABSOLUTE MAXIMUM RATINGS (1)

VH	0.3V to +20V
SW0.3V (-2V fo	or 50ns) to +20V
VL	0.3V to +16V
MID	0.3V to +12V
BST to SW	0.3V to +5.5V
All other pins to GND	0.3V to +5.5V
Continuous power dissipation (7	$\Gamma_{A} = +25^{\circ}C)^{(2)}$
	2.97W
Junction temperature	150°C
Lead temperature (solder)	260°C
Storage temperature	-65°C to +150°C

Recommended Operating Conditions (3)

VL to GND	4V to 5.5V
VH to GND	6V to 8.7V
Operating junction temp.(T _J)	40°C to +125°C

Thermal Resistance (4) θ_{JA} $\boldsymbol{\theta}_{JC}$ QFN-26 (4mmx4mm)......42......9 °C/W

NOTES:

- 1) Exceeding these ratings may damage the device.
- The maximum allowable power dissipation is a function of the maximum junction temperature $T_{\rm J}$ (MAX), the junction-to-ambient thermal resistance $\theta_{\rm JA},$ and the ambient temperature T_A. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P_D (MAX) = $(T_J$ $(MAX)-T_A)/\theta_{JA}$. Exceeding the maximum allowable power dissipation produces an excessive die temperature, causing the regulator to go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.

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4) Measured on JESD51-7, 4-layer PCB.

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 $V_{IN} = VL = 5V$, $T_A = 25$ °C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
DC/DC Parameter						
LV side input over-voltage threshold	V _{LOVP}	VL rising until the switching is off		5.75		V
LV side input over-voltage threshold hysteresis	V LOVP			200		mV
		MODE = high, VH = 7.6V	4.4	4.5	4.6	V
VCC LDO output	Vcc	MODE = low, VH = 0V, VL = 5V		4.5		V
Input power good threshold	V _{UVLO}	VL rising VL falling		3.9 3.6		V
High-side NMOS on	Q _{1_ON}	T _A = 25°C		19		mΩ
resistance	Q1_0N	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$		19	29	11122
Low-side NMOS on resistance	Q _{2 ON}	T _A = 25°C		24		mΩ
	-12_0.1	$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$		24	36	
Reverse blocking NMOS on resistance	Q _{BR_ON}	$T_A = 25^{\circ}C$ $T_A = -40^{\circ}C \text{ to } +125^{\circ}C$		10 10	15	mΩ
Peak current limit for high-side NMOS		Step-down mode	6	8	10	Α
Peak current limit for low-side		Step-up CC mode	7	9	11.5	Α
NMOS		Step-up TC mode	3	4	6.5	Α
Operating frequency	Fsw		1150	1300	1450	kHz
Charging Operation						
Input quiescent current	I _{IN}	Battery float, charging is enabled			2.5	mA
Trickle charge threshold	V _{BATT_TC}	V _{BATT} rising		5.9		V
Trickle charge threshold hysteresis		V _{BATT} falling		240		mV
Trickle input current	I _{TC}			300		mA
Constant fast charge current	Icc	$R_{ISET} = 215k\Omega$	0.79	1.00	1.20	Α
Constant last charge current	ICC	R_{ISET} = 86.6k Ω	2.2	2.46	2.7	Α
Termination charge current	I _{BF}	As the percentage of Icc	2.5	10	17.5	%
remination enarge current	IDF	If 10% * I _{CC} < 167mA	38	150		mA
Input voltage clamp reference	VIN_CIAMP		1.18	1.20	1.22	V
		$R_{\text{ILIM}} = 475 \text{k}\Omega$	400	455	500	mA
Input current limit	I _{IN_LMT}	R _{ILIM} = 158kΩ	1.2	1.36	1.5	Α
		$R_{ILIM} = 78.7k\Omega$	2.56	2.74	3	Α
Termination charge voltage	VBATT_FULL		8.35	8.38	8.41	V
Auto-recharge threshold				8.00		V
Battery over-voltage threshold	V _{BATT_OV}	As the percentage of VBATT_FULL	101	103.3	105	%

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 $V_{IN} = VL = 5V$, $T_A = 25$ °C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Discharge Operation						
Output voltage range		I _{OUT} = 0A	4.5		5.5	V
Feedback voltage			1.18	1.20	1.22	V
Feedback input current		V _{FB} = 1.2V			300	nA
Output over-voltage threshold			5.6	5.75	6.0	V
Output over-voltage threshold hysteresis				160		mV
Shutdown current		Discharging is disabled			20	μΑ
		R _{OLIM} = 365kΩ	0.5	0.58	0.68	
Programmable output current limit	Іоит_ыміт	R _{OLIM} = 130kΩ	1.5	1.64	1.8	A
mint		R _{OLIM} = 66.5kΩ	3	3.2	3.44	
Dottom: IIV/throokald	VBATTUV	Rising		6.28		V
Battery UV threshold	V BATTUV	Falling		5.75		V
ACOK, CHG output low voltage		Sinking 1.5mA			400	mV
ACOK, CHG leakage current		Connected to 5V			1	μΑ
LED blinking frequency		Стмг = 0.1µF, I _{CHG} = 1A		1		Hz
EN, MODE input logic low voltage					0.4	V
EN, MODE input high voltage			1.4			V
ID velle en entre d		I _{CHG} = 1A in charge mode RIB=53.3K		0.39		V
IB voltage output		I _{DIS} = 1A in discharge mode RIB=53.3K		0.42		V
Trickle charge time		C _{TMR} = 0.1µF, stay in TC mode, I _L = 1A		30		mins
Total current charge time		$C_{TMR} = 0.1 \mu F$, $I_L = 1A$		5.4		hours

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 $V_{IN} = VL = 5V$, $T_A = 25$ °C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Protection						
NTC low temp rising threshold	V_{COLD}	As percentage of V _{VREF}	69.3	69.9	70.5	%
NTC low temp rising threshold hysteresis		As percentage of V _{VREF}		0.8		%
NTC cool temp rising threshold	Vcool	As percentage of VVREF	67.2	67.7	68.4	%
NTC cool temp rising threshold hysteresis		As percentage of V _{VREF}		1.11		%
NTC warm temp falling threshold	Vwarm	As percentage of VVREF	54.7	55.3	55.9	%
NTC warm temp falling threshold hysteresis		As percentage of V _{VREF}		1.5		%
NTC hot temp falling threshold	V _{HOT}	As percentage of VVREF	46.9	47.4	47.9	%
NTC hot temp falling threshold hysteresis		As percentage of V _{VREF}		1.5		%
No load shutdown delay time	tnoload			20		S
No load shutdown current threshold	INOLOAD			50		mA
Threshold between long and short touch				2.5		s
LED auto-off timer delay				5		s
Voltage-Based Fuel Gauge						
Charge Mode						
First level of battery voltage threshold		Battery voltage rising		7.33		V
Hysteresis				420		mV
Second level of battery voltage threshold		Battery voltage rising		7.73		V
Hysteresis				420		mV
Third level of battery voltage threshold		Battery voltage rising		8.15		V
Hysteresis				420		mV

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ELECTRICAL CHARACTERISTICS(continued)

 $V_{IN} = VL = 5V$, $T_A = 25$ °C, unless otherwise noted.

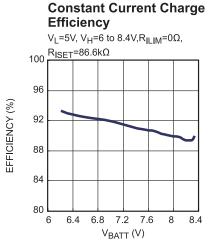
Parameter	Symbol	Condition	Min	Тур	Max	Units
Discharge Mode						
Fourth level of battery voltage threshold		Battery voltage falling		7.96		V
Hysteresis				420		mV
Third level of battery voltage threshold		Battery voltage falling		7.57		V
Hysteresis				420		mV
Second level of battery voltage		Battery voltage falling		7.17		V
Hysteresis				420		mV
First level of battery voltage		Battery voltage falling		5.97		V
Hysteresis				420		mV
Cell Balancing						
Discharge MOSFET on	HS			6		Ω
resistance	LS			6		1 12
Cell balance start voltage	V _{CBST}		3.4	3.5	3.6	V
Balance threshold	ΔV_{CELL}			65		mV
Balance threshold hysteresis (5)				30		mV

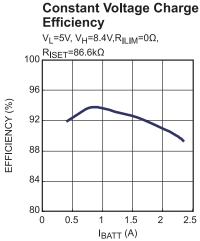
NOTES:

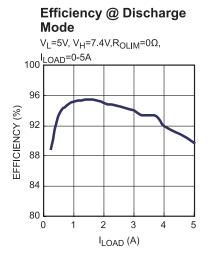
5) Guaranteed by design



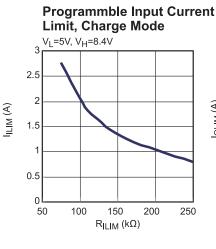
 V_{IN} = VL= 5V, V_{BATT} = VH = 7.4V, C_{VL} = C_{VH} = 22 μ F, L1 = 2.2 μ H, C_{TMR} = 0.1 μ F, R1 = 76.8 $k\Omega$, R2 = 24.3 $k\Omega$, R3 = 27.4 $k\Omega$, R4 = 10 $k\Omega$, battery simulator, unless otherwise noted.

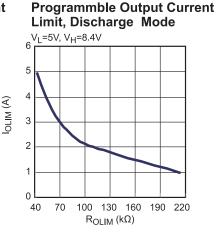


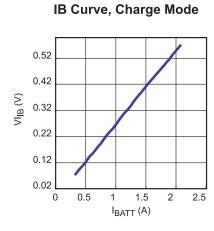


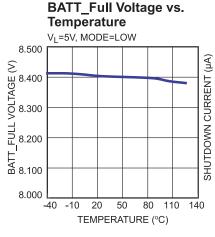


Programmble Charge Current, Charge Mode V_L=5V, V_H=6.6V 2.5 2 1.5 1 0.5 0 100 50 150 200 250 300 $R_{ISET}(k\Omega)$





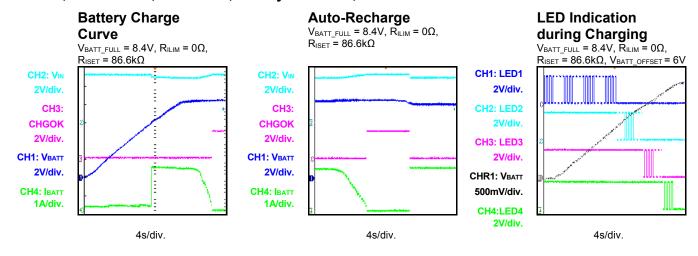


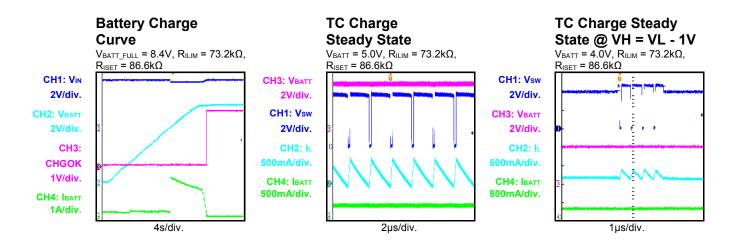


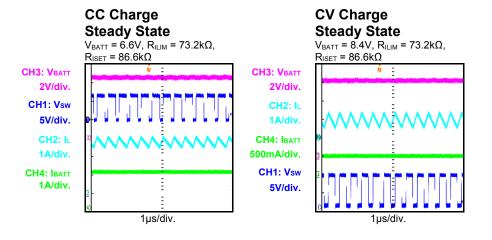
Shutdown Current vs.



 $V_{IN} = VL = 5V$, $V_{BATT} = VH = 7.4V$, $C_{VL} = C_{VH} = 22\mu F$, $L1 = 2.2\mu H$, $C_{TMR} = 0.1\mu F$, $R1 = 76.8k\Omega$, $R2 = 0.1\mu F$, $R1 = 1.8k\Omega$ 24.3kΩ, R3 = 27.4kΩ, R4 = 10kΩ, battery simulator, unless otherwise noted.

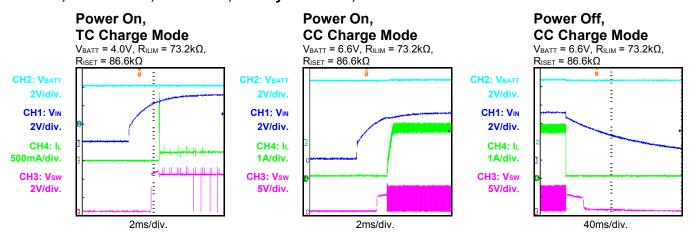


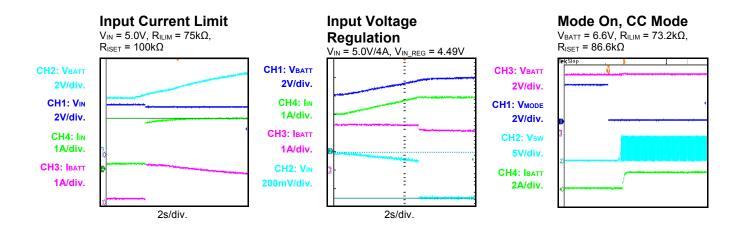


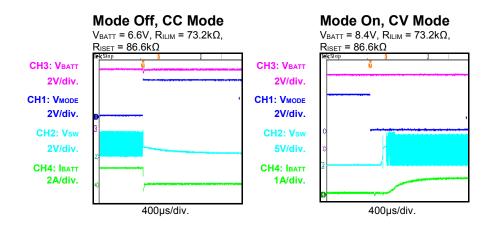




 V_{IN} = VL = 5V, V_{BATT} = VH = 7.4V, C_{VL} = C_{VH} = 22 μ F, L1 = 2.2 μ H, C_{TMR} = 0.1 μ F, R1 = 76.8 $k\Omega$, R2 = 24.3 $k\Omega$, R3 = 27.4 $k\Omega$, R4 = 10 $k\Omega$, battery simulator, unless otherwise noted.

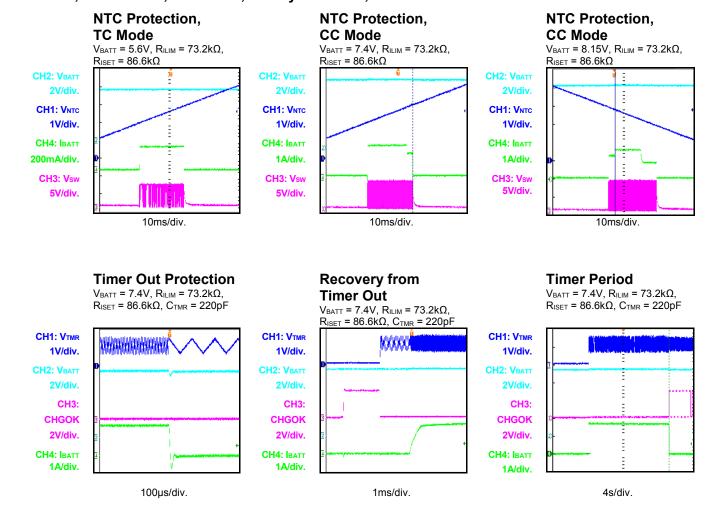


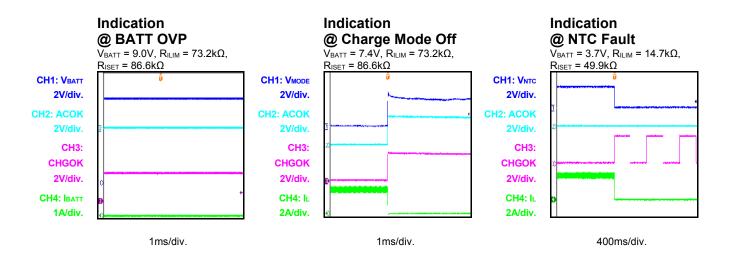






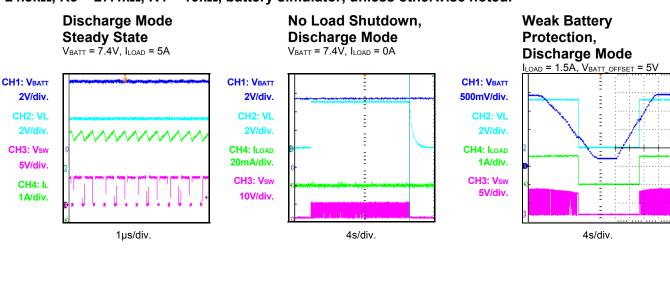
 $V_{IN} = VL = 5V$, $V_{BATT} = VH = 7.4V$, $C_{VL} = C_{VH} = 22\mu F$, $L1 = 2.2\mu H$, $C_{TMR} = 0.1\mu F$, $R1 = 76.8k\Omega$, $R2 = 0.1\mu F$, $R1 = 1.8k\Omega$ 24.3kΩ, R3 = 27.4kΩ, R4 = 10kΩ, battery simulator, unless otherwise noted.

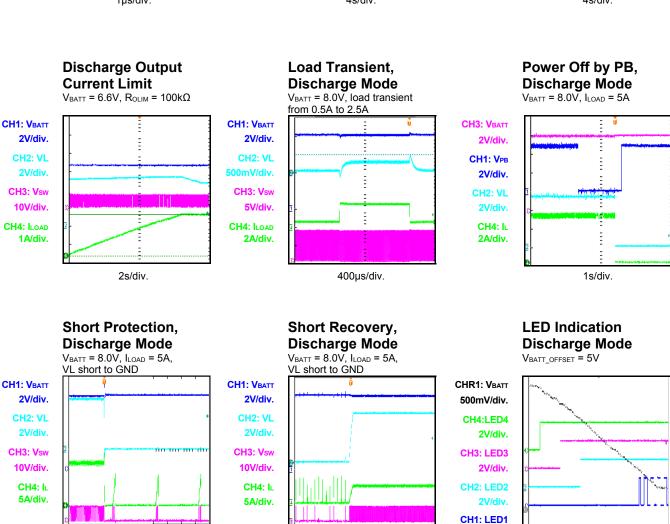






 V_{IN} = VL = 5V, V_{BATT} = VH = 7.4V, C_{VL} = C_{VH} = 22μF, L1 = 2.2μH, C_{TMR} = 0.1μF, R1 = 76.8kΩ, R2 = 24.3kΩ, R3 = 27.4kΩ, R4 = 10kΩ, battery simulator, unless otherwise noted.





4ms/div

400µs/div.

2V/div.

2s/div.



BLOCK DIAGRAM

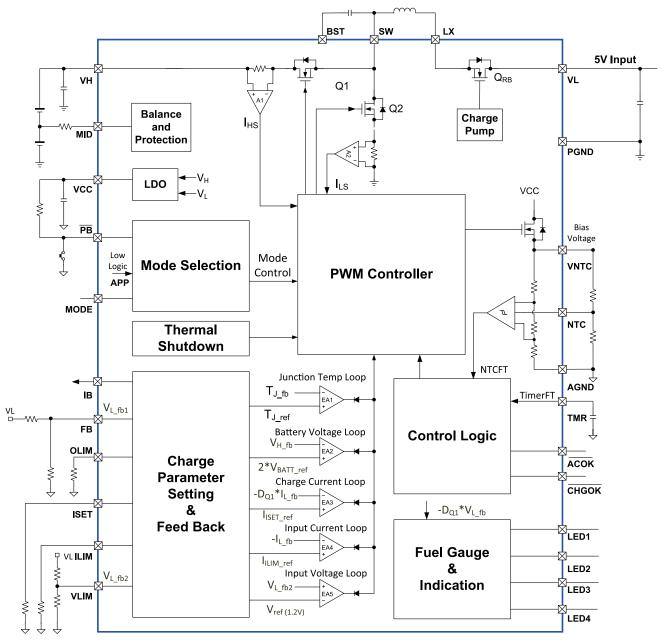


Figure 1: Block Diagram for 2-Cell Charge Mode

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BLOCK DIAGRA

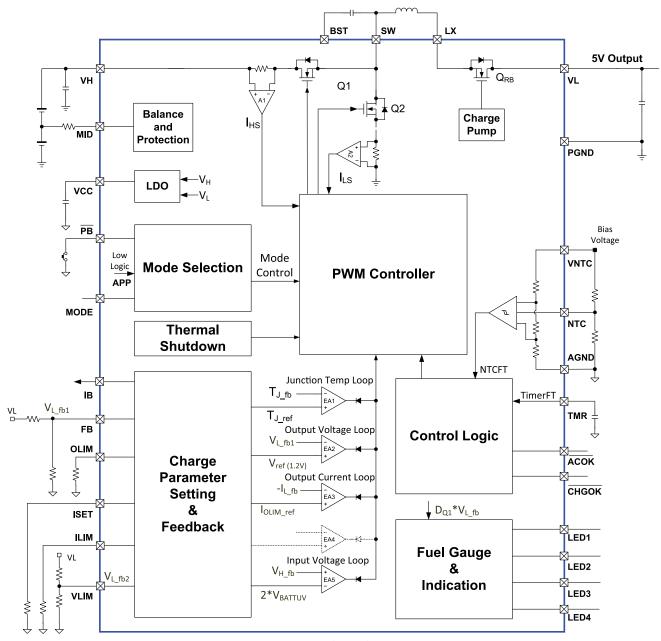


Figure 2: Block Diagram for 2-Cell Discharge Mode

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FLOW CHART

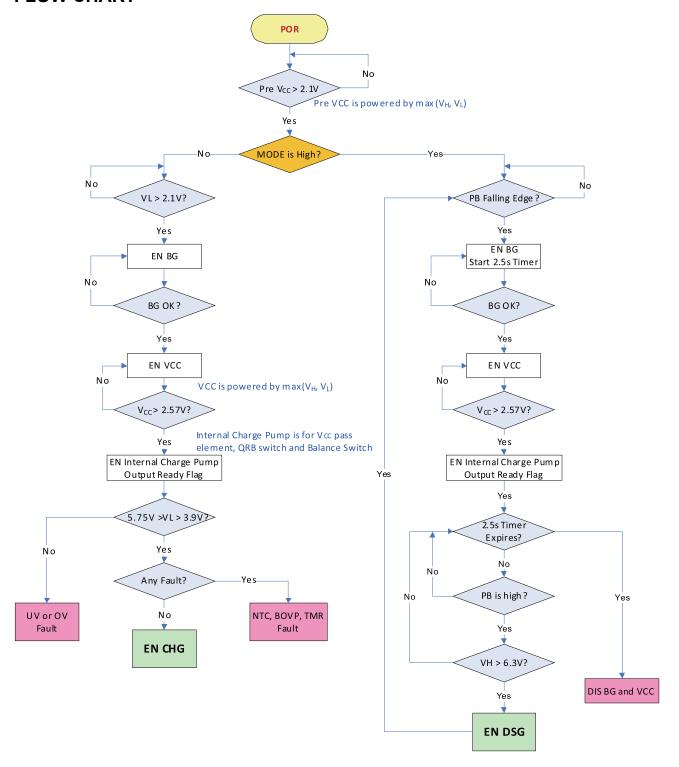


Figure 3: Input Power Start-Up Flow Chart

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FLOW CHART

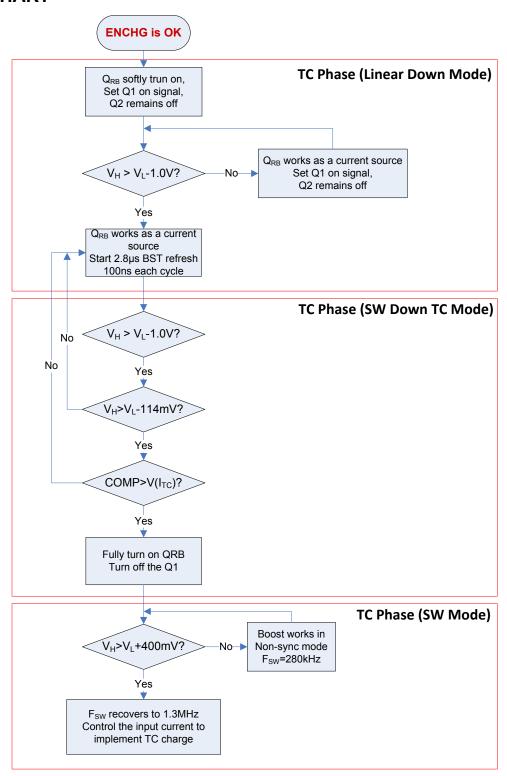


Figure 4: Three-Phase Trickle Charge

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OPERATION

The MP2639C is a highly integrated, switch-mode battery charger with a sophisticated control strategy to charge 2-cell series Lithium-ion or Lithium-polymer batteries from a 5V adapter or USB input.

MODE Control

When MODE is low, the MP2639C works in charging mode to charge a 2-cell series battery from 5V. The MP2639C operates in step-up mode at this time, and Q2 works as the active switch, while Q1 works as the synchronous switch.

When MODE is high, the MP2639C is configured to discharge mode. Once discharge mode is enabled, the MP2639C operates in reverse to achieve a 5V output from a 2-cell battery via step-down mode (see Table 1).

Table 1: Operation MODE Table

Adapter Term	BATT Term	MODE	CHG/DIS	Active SW	Topology
VL VH	High	DSG	Q1	Step-down	
	VH	Low	CHG	Q2	Step-up

Internal Power Supply

The VCC output is used to power the internal circuit and the MOSFET driver. This output is supplied by the higher terminal voltage value of VL or VH. After VL is set, the internal reference voltage is set up during charge mode. In discharge mode, VH is always higher than the output voltage, so VCC is always comes from VH when VH is higher than the under-voltage lockout (UVLO).

Connect an external capacitor from VCC to AGND. The VCC output current limit is 50mA. Figure 3 shows the MODE selection and power start-up flow chart in each mode.

Battery Current Monitor

The MP2639C has an IB pin to represent the real battery current in both charge and discharge mode. The current flowing out from IB is proportional to the real battery current. An external, precise, sense resistor can convert the current signal to a voltage signal. Calculate the IB voltage with Equation (1):

$$V_{IB} = \frac{3 \cdot I_{BATT}}{400k} \cdot R_{IB} \tag{1}$$

The sense gain can be programmed by the external resistor (R_{IB}) connected from IB to GND. For example, for a 40k Ω R_{IB} , a 0.3V IB value represents a 1A battery current.

CHARGE MODE

Input Power Start-Up

As shown in Figure 3, once VCC exceeds the UVLO threshold, the MP2639C qualifies both the LV side and HV side voltage according to the MODE status.

In charging mode, VL is the input power terminal. Once $V_{\text{OVLO}} > V_{\text{LV}} > V_{\text{UVLO}}$ and no fault occurs, the MP2639C is ready for charging.

As shown in Figure 4, depending on VH, the MP2639C operates in three different tricklecurrent charge modes: linear down mode, switch down mode, and switch TC mode (see Table 2).

- 1. Linear Down Mode: When VH < VL 1V, the Q_{RB} MOSFET works linearly to charge the battery with the trickle charge current. At this time, the pulse-width modulation (PWM) block delivers the Q2 off signal and Q1 on signal. The BST refresh block is still disabled, so the Q1 MOSFET cannot be on. When VH > VL 1V, a 2.8µs BST refresh window launches. In this window, the low-side Q2 MOSFET is turned on for 100ns each cycle (1.3MHz). Whenever Q1 is set to be on for 270µs, the 2.8µs BST refresh window is launched again.
- 2. Switch Down Mode: When VH > VL 114mV, Q_{RB} is fully on, Q1 is turned off, Q2 is switching, and F_{SW} is lowered to 280kHz.
- 3. Switch TC Mode: When VH > VL + 400mV, QRB remains fully on, Q1 is turned off, Q2 is switching, and Fsw recovers to 1.3MHz.



Table	2:	Operation	Mode
-------	----	-----------	------

V _{BATT} Rising, Quit Linear Down Mode (enter switch down mode)	VH > VL - 114mV
VBATT Falling, Enter Linear Down Mode (quit switch down mode)	VH < VL - 342mV
VBATT Rising, Quit Switch Down Mode (enter normal switch mode)	VH > VL + 400mV
V _{BATT} Falling, Enter Switch Down Mode (quit normal switch mode)	VH < VL + 114mV

Battery Charge Profile

The MP2639C provides three main charging phases: trickle-current, constant-current charge, and constant-voltage charge (see Figure 5).

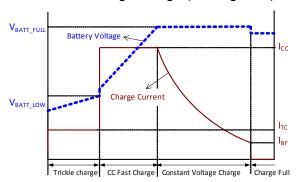


Figure 5: Battery Charge Profile

- 1. Phase 1 (trickle-current charge): When the battery voltage is lower than V_{BATT LOW}, the MP2639C applies a safe trickle-charge current (I_{TC}) to the deeply depleted battery until the battery voltage reaches trickle charge to the fast charge threshold ($V_{BATT\ LOW}$). If V_{BATT_LOW} is not reached before the trickle-charge timer expires, the cycle ceased, charge is and corresponding timeout fault signal asserted. See the Safety Timer section on page 21 for more detail.
- Phase 2 (constant-current charge): When the battery voltage exceeds V_{BATT_LOW}, the MP2639C stops the trickle-current charge phase and enters constant-current charge (fast charge) phase with a soft start. The fast charge current can be programmed via ISET.
- 3. Phase 3 (constant-voltage charge): When the battery voltage rises to the charge-full

voltage (V_{BATT_FULL}), the charge current begins to taper off. The charge cycle is considered complete when the CV loop is dominated, and the charge current reaches the battery-full termination threshold. A 500 μ s force charge time is designed for each charge cycle. After the 500 μ s force charge time expires, the charge full signal is allowed to assert.

If I_{BF} is not reached before the safety charge timer expires, the charge cycle is ceased, and the corresponding timeout fault signal is asserted. See the Safety Timer section for more detail.

A new charge cycle starts when the following conditions are valid:

- The input power is re-plugged.
- MODE is toggled from high to low.
- No thermistor fault at NTC.
- · No safety timer fault.
- No battery over-voltage.

Automatic Recharge

When the battery is fully charged and the charging is terminated, the battery may be discharged for system consumption or self-discharge. The MP2639C starts a new charging cycle automatically without requiring a manual restart of a charging cycle.

Charge Current Setting

ISET is used to program the charge current. The setting formula is shown in Equation (2):

$$I_{CHG} = \frac{640(k\Omega)}{3 \times R_{ISET}}(A)$$
 (2)

Battery Over-Voltage Protection (OVP)

The MP2639C is designed with a built-in battery over-voltage limit of 103.3% of V_{BATT_FULL}. When a battery over-voltage event occurs, the MP2639C suspends the charging immediately.

Non-Sync Mode

When the input current at the VL side is lower than 330mA, the MP2639C turns off Q1 and switches to non-sync operation.

Safety Timer

The MP2639C uses an internal timer to terminate the charging. The timer remains

active during the charging process. An external capacitor between TMR and AGND programs the charge cycle duration. An internal current source charges and discharges the external capacitor alternatively. When the voltage across C_{TMR} is lower than 0.7V, the internal current source charges C_{TMR}. Once the voltage exceeds 1.5V, the internal current source begins to discharge C_{TMR}. As a result, the voltage across C_{TMR} oscillates between 0.7V and 1.5V periodically, like a triangle wave. There are two counter limits for the trickle charge and total charge processes: 45056 for trickle charge and 3407872 for CC and CV Once the counter reaches the corresponding limit, the timer expires, and the charging is suspended (see Figure 6).

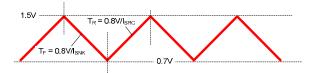


Figure 6: Voltage Profile of TMR

In trickle-charge mode, the input trickle-charge current is fixed at 300mA. The trickle-charge time ($\tau_{TC\ TMR}$) is set using Equation (3):

$$\tau_{\text{TRICKLE_TMR}} = 33.7 \text{mins} \times \frac{C_{\text{TMR}}(\mu F)}{0.1 \mu F} \tag{3}$$

In CC and CV mode, the internal I_{OSC} is proportional to the reference of the inductor current and is independent of the input current. The total charge time (τ_{TOTAL_TMR}) is set using Equation (4):

$$\tau_{\text{TOTAL_TMR}} = 6.05 Hours \times \frac{C_{\text{TMR}}(\mu F)}{0.1 \mu F} \times \frac{1A}{I_{\text{L}}(A) + 0.08} \tag{4}$$

In the event of an NTC hot and cold fault, the charging timer should be suspended. Once the NTC fault is removed, the timer continues counting from the value before an NTC fault.

Negative Temperature Coefficient (NTC) Thermistor

"Thermistor" is the generic name given to thermally sensitive resistors. A negative temperature coefficient thermistor is called a thermistor, typically. Depending on the manufacturing method and the structure, there are many shapes and characteristics available for various purposes. The thermistor resistance values, unless otherwise specified, are classified at a standard temperature of 25°C. The resistance of a temperature is solely a function of its absolute temperature.

The relationship between the resistance and the absolute temperature of a thermistor is shown in Equation (5):

$$R_1 = R_2 \cdot e^{\beta \left(\frac{1}{T_1} - \frac{1}{T_2}\right)}$$
 (5)

Where R1 is the resistance at absolute temperature T1, R2 is the resistance at absolute temperature T2, and β is a constant that depends on the material of the thermistor.

The MP2639C monitors the battery's temperature continuously by measuring the voltage at NTC during charge mode. This voltage is determined by the resistor divider, whose ratio is produced by different resistances of the NTC thermistor under different ambient temperatures of the battery.

The MP2639C sets a pre-determined upper and lower bound of the range internally. If the voltage at NTC goes out of this range, then the temperature is outside of the safe operating limit. At this time, charging stops unless the operating temperature returns to the safe range.

To satisfy the JEITA requirement, the MP2639C monitors four temperature thresholds: the cold battery threshold ($T_{NTC} < 0^{\circ}C$), the cool battery threshold ($0^{\circ}C < T_{NTC} < 10^{\circ}C$), the warm battery threshold ($45^{\circ}C < T_{NTC} < 60^{\circ}C$), and the hot battery threshold ($T_{NTC} > 60^{\circ}C$). For a given NTC thermistor, these temperatures correspond to V_{COLD} , V_{COOL} , V_{WARM} , and V_{HOT} . When $V_{NTC} < V_{HOT}$ or $V_{NTC} > V_{COLD}$, charging and the timers are suspended. When $V_{HOT} < V_{NTC} < V_{WARM}$, the charge-full voltage (V_{BATT_FULL}) is reduced by 240mV from the programmable threshold. When $V_{COOL} < V_{NTC} < V_{COLD}$, the charging current is reduced to half of the programmed charge current (see Figure 7).

Note: V_{NTC} is the ratio of the voltage at NTC pin and the voltage at VNTC pin.

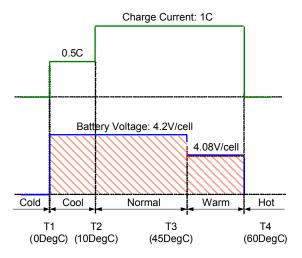


Figure 7: JEITA-Compatible NTC Window

VNTC Output

VNTC is an input pin used to pull up both the internal and external resistor dividers to the same point (see Figure 8). VNTC is connected to VCC via an internal switch. In charging mode, the switch is turned on, and VNTC is connected to VCC. In discharge mode, the switch is off, and VNTC is bridged off from VCC.

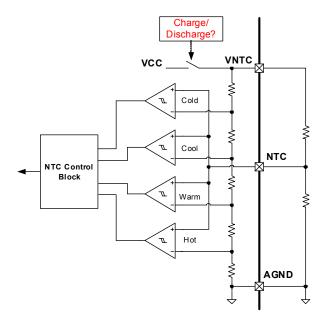


Figure 8: NTC Protection Circuit

Input Voltage-Based and Input Current-Based Power Management

To meet the USB maximum current limit specification and avoid overloading the adapter, the MP2639C features both input current- and input voltage-based power management by monitoring the input current and input voltage continuously. The total input current limit can be programmed to prevent the input source from overloading. When the input current reaches its limit, the charge current tapers off to keep the input current from increasing further. The input current limit can be calculated with Equation (6):

$$I_{ILIM} = \frac{640(k\Omega)}{3 \times R_{ILIM}}(A)$$
 (6)

If the preset input current limit is higher than the rating at the adapter, the back-up input voltage-based power management also works to prevent the input source from being overloaded. When the input voltage falls below the input voltage limit due to an overload, the charge current is reduced to keep the input voltage from dropping further.

The input voltage clamp threshold can be programmed by VLIM. The internal reference of the input voltage loop is 1.2V, so the input voltage clamp limit can be calculated with Equation (7):

$$V_{IN_REG} = 1.2V \times \frac{R3 + R4}{R4}$$
 (7)

Indication

The MP2639C integrates indicators for the conditions shown in Table 3.

Table 3: Indication in Difference Cases

Cha	rging State	ACOK	CHGOK
	In Charging	Low	Low
Mode is low	Charging complete, sleep mode, charge disable, battery OVP	Low	High
	NTC hot or cold fault, timer fault,	Low	Blinking at fixed 1Hz
Mode is high	Discharging	High	High



DISCHARGE MODE

Discharge Control

When MODE is configured high, discharge mode is enabled. However, discharging can only be enabled or disabled when the push button pin (PB) is configured properly.

A short push is defined as PB being pulled low for less than 2.5s. A long push is defined as PB being pulled low for longer than 2.5s.

In the MP2639C, discharging is enabled only when MODE is high and a short push is detected. Discharging is disabled once MODE is pulled low or a long push is detected.

Figure 9 shows the steps below.

 Before t0, MODE is high, and discharging has already been enabled. PBDIS is the enable signal of the discharging. If PBDIS is high, discharging is enabled. If PBDIS is low, discharging is disabled.

- 2) During t0, PB is pulled low, and the 2.5s timer is reset. PB is released to high before the 2.5s timer expires, so a short push is detected. PBDIS remains high, and discharging continues.
- 3) During t1, PB is pulled low again, and the 2.5s timer is reset. PB remains low until the 2.5s timer expires, so a long push is detected. PBDIS is pulled low, and discharging ceased.
- At the moment of t2, another long push is detected. Discharging is still disabled and PDBIS remains low.
- 5) At the moment of t3, a short push is detected, and PDBIS rises high. Discharging is enabled.

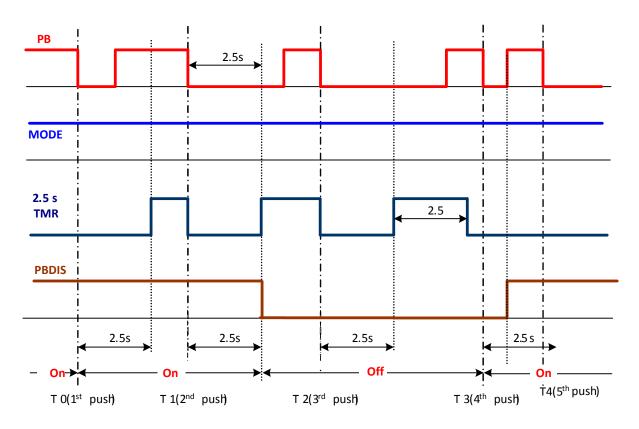


Figure 9: Push Button Detection Profile

Since the MP2639C is in sleep mode, if PB is pulled down to AGND for less than 2.5s (short push), the IC enters discharge mode, and the LEDs display the battery capacity. After 5s, the LED pins switch to open drain automatically to minimize the battery quiescent current. For the LED to display the battery capacity, short push PB.

No-Load Automatic Shutdown

In discharge mode, the MP2639C monitors the discharge current continuously. When the discharge current (I_{BATT}) is lower than 50mA, discharging can be shut down after 20s automatically (see Figure 10).

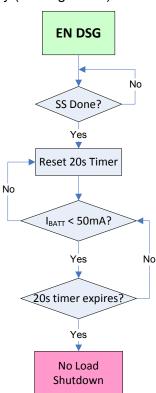


Figure 10: No-Load Shutdown Detection

Output Over-Voltage Protection (OVP)

The MP2639C has an internal, output, overvoltage protection (OVP). If the voltage at the VL node is higher than 5.75V, and an external, abnormal voltage is added or FB is pulled to GND falsely, then the MP2639C disables the discharge and turns off the $Q_{\rm RB}$ MOSFET. When the output voltage returns to a safe level, the MP2639C restarts the discharging.

Output Over-Current Limit (OCL)

The MP2639C features an output over-current limit (OCL), which can be programmed by the resistor connected from OLIM to AGND. When the output current flowing out from the VL node exceeds the output over-current limit, the MP2639C regulates the duty cycle to maintain the output current at this limit, so the output voltage drops accordingly. The output current limit can be set using Equation (8):

$$I_{OLIM} = \frac{640(k\Omega)}{3 \times R_{OLIM}}(A)$$
 (8)

Output Short-Circuit Protection (SCP)

The MP2639C monitors the VL voltage continuously. If VL drops below 3.9V, an event of the output short circuit is detected. The MP2639C works in hiccup mode with 1.2ms intervals, and the peak current limit of the high-side switch is cut by half (see Figure 11).

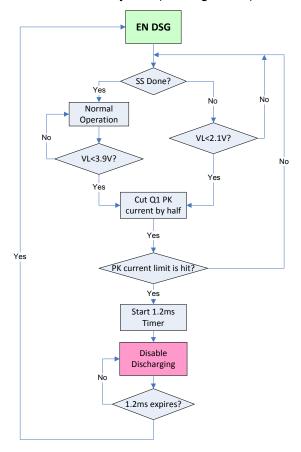


Figure 11: Output Short-Circuit Protection

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Over-Discharge Control

The MP2639C has a battery over-discharge control scheme to avoid over-discharging. During discharging, the MP2639C shuts down automatically when the battery voltage declines to 5.75V, and the MP2639C recovers to discharge when the battery voltage is over 6.28V.

Battery Cell Balance and Protection

The MP2639C provides battery cell balance and protection for 2-cell applications. The MP2639C senses the voltage across each cell. If the two cell voltages are too different, the balance function begins, and the internal discharge circuit is turned on to decrease the charge current of the cell with the higher voltage. If the voltage across one of the cells exceeds the battery OVP threshold, the charging stops. If the two cell voltages are still too different, the cell with the higher voltage discharges to balance until the two cell voltages match or the part recovers from OVP (120mV lower than the OVP threshold) then recharges. And cell balance has higher priority than charge done. Even total battery voltage reaches termination voltage, MP2639C keeps this voltage and doesn't charge done until exits balance.

The MP2639C integrates the balance MOSFET and control circuit (see Figure 12).

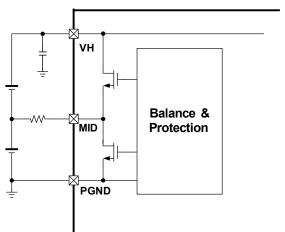


Figure 12: Block Diagram of the Battery Balance

The balance current (less than 200mA) depends on the external resistor from MID to the middle of the 2-cell battery. If a larger balance current is needed, then refer to the external balance circuit in Figure 18.

The balancing algorithm enables automatically when the following conditions are true:

- The balance block is only active when a valid power source is present and charging is enabled.
- 2. At least one of the cell voltages is higher than the balance starting voltage (typical 3.5V).
- 3. The voltage difference between the cells is higher than the balance threshold (65mV).

The MP2639C detects the cell with the lower voltage (V_{CMIN}) and checks the voltage difference between each cell. If the differential voltage is higher than the balance threshold (65mV), the related balance MOSFET is turned on, and the charge current of the cell with the higher voltage is decreased.

The balancing action is suppressed if the higher cell voltage is less than the cell-balance start voltage (V_{CBST}) or the cell-voltage measurement is active.

In each balance cycle, the cell voltage measures for about 200µs and balances for about 200ms. Cell measurements are frozen when the balance is ongoing.

The cell balance flow chart is shown in Figure 13.

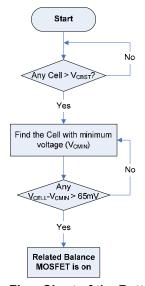


Figure 13: Flow Chart of the Battery Balance



Voltage-Based Fuel Gauge

The MP2639C integrates four comparators and an open-drain circuit to indicate the fuel gauge via four LEDs during both charge and discharge mode (see Figure 14). The MP2639C compares the battery voltage with four voltage references to reveal the capacity of the battery, with four options of 25%, 50%, 75%, and 100%.

The indication plan is shown in Table 4.

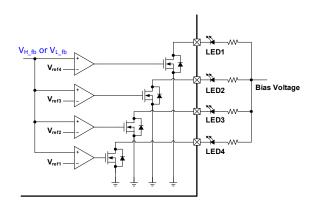


Figure 14: Block Diagram of Fuel Gauge

Table 4: Voltage-Based Fuel Gauge Indication

Table 4: Voltage Basea I del Gauge maleation					
2-Cell Charge	LED1	LED2	LED3	LED4	CHG
Done	On	On	On	On	Off
8.4V	On	On	On	On	On
8.2V <v<sub>BATT<8.4V</v<sub>	On	On	On	Blinking at 1Hz	On
7.8V <v<sub>BATT<8.2V</v<sub>	On	On	Blinking at 1Hz	Off	On
7.4V< V _{BATT} <7.8V	On	Blinking at 1Hz	Off	Off	On
V _{BATT} <7.4V	Blinking at 1Hz	Off	Off	Off	On

2-Cell Discharge	LED1	LED2	LED3	LED4	CHG
8V <v<sub>BATT</v<sub>	On	On	On	On	Off
7.6V <v<sub>BATT<8V</v<sub>	On	On	On	Off	Off
7.2V <v<sub>BATT<7.6V</v<sub>	On	On	Off	Off	Off
6V <v<sub>BATT<7.2V</v<sub>	On	Off	Off	Off	Off
V _{BATT} <6V	Blinking at 1Hz	Off	Off	Off	Off

During discharge mode, to minimize the power consumption of the gauge indication, the indication control is designed in the MP2639C

achieved by PB. When PB is short pushed, the gauge indication is enabled and disabled after 5s automatically.

Discharge Line Drop Compensation

The MP2639C integrates a discharge line compensation function to compensate for the voltage drop across the USB cable automatically.

The output voltage is compensated by feeding the output current to the top feedback resistance (R1) (see Figure 15).

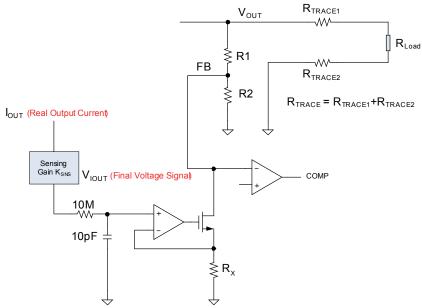


Figure 15: Block Diagram of Line Drop Compensation

If the trace to the load is long, there is a voltage drop between V_{OUT} and V_{LOAD} . The voltage at the output terminator (V_{OUT}) is not equal to the voltage at the load (V_{LOAD}). The voltage drop is described in Equation (9):

$$V_{LOAD} = V_{OUT} - I_{OUT} \times R_{TRACE}$$
 (9)

Where R_{TRACE} is the resistance of the cable.

To maintain an accurate and constant load voltage, output line drop compensation is necessary. The MP2639C offers a compensation method by adjusting the FB voltage (V_{FB}) slightly according to the load current. The relation between V_{OUT} and V_{FB} is described in Equation (10):

$$\frac{V_{OUT} - V_{FB}}{RI} = \frac{V_{FB}}{R2} + \frac{V_{IOUT}}{R_X}$$
 (10)

Where V_{IOUT} is the voltage signal representing the real output current.

The output voltage after compensation is shown in Equation (11):

$$V_{OUT} = \frac{R1 + R2}{R2} \times V_{FB} + \frac{I_{OUT} \times K_{SNS}}{R_{x}} \times R1$$
 (11)

Ensure that V_{LOAD} is always equal to the output setting voltage with Equation (12):

$$V_{LOAD} = \frac{R1 + R2}{R2} \times V_{FB}$$
 (12)

To solve Equation (11) and Equation (12), use the value calculated from Equation (13):

$$\frac{I_{\text{OUT}} \times K_{\text{SNS}}}{R_{\text{X}}} \times RI = I_{\text{OUT}} \times R_{\text{TRACE}}$$
(13)

Given a tested R_{TRACE} , R1 should be selected according Equation (14):

$$R1 = \frac{R_{TRACE} \times R_{X}}{K_{SNS}}$$
 (14)

Where R_X is 150k Ω , and K_{SNS} is 0.3. In practice, R_{TRACE} ranges from 120 - 200m Ω .



MP2639C - 5V, 2.5A, BOOST CHARGER WITH 5V, 5A INVERTED DISCHARGE

Calculate R2 with Equation (15):

$$R2 = \left(\frac{V_{FB}}{V_{LOAD} - V_{FB}}\right) \times R1 \tag{15}$$

Where V_{LOAD} is equal to the regulation voltage, and V_{FB} is 1.2V.

For example, given an R_{TRACE} of $200m\Omega$, calculate R1 with Equation (16):

R1=
$$\frac{R_{TRACE} \times R_{x}}{K_{SNS}} = \frac{0.2 \times 150k}{0.3} = 100(k\Omega)$$
(16)

Where R2 is $31.6k\Omega$ for a 5V regulation.

Given an R_{TRACE} of $120m\Omega$, calculate R1 with Equation (17):

$$R1 = \frac{R_{TRACE} \times R_{X}}{K_{SNS}} = \frac{0.12 \times 150k}{0.3} = 60(k\Omega)$$
(17)

Where R2 is $18.9k\Omega$ for a 5V regulation.

Additionally, no matter how much the drop compensation is, the maximum sink current in FB pin is 4uA, so for R1=60k, compensation limit is 240mV. Given a 5V output application, the maximum regulation voltage at VL is 5.24V.



APPLICATION INFORMATION

Setting the Input Current Limit in Charge Mode

The input current limit setting is set according to the input power source capability. The input current limit can be set through ILIM. Connect a resistor from ILIM to AGND to program the input current limit. The relationship is calculated using Equation (18):

$$I_{ILIM} = \frac{640(k\Omega)}{3 \times R_{ILIM}}(A)$$
 (18)

To set the input current limit to 3A, choose R_{ILIM} to be 71.5k $\Omega.$ To set the input current limit to 500mA according to the USB input request, choose R_{ILIM} to be 432k $\Omega.$ If R_{ILIM} is $0\Omega,$ then there is no limit on the input current.

Setting the Charge Current

The charge current of the MP2639C can be set by an external resistor (R_{ISET}) according to Equation (19):

$$I_{CHG} = \frac{640(k\Omega)}{3 \times R_{ISET}}(A)$$
 (19)

The charge current can be programmed to 2.5A. The expected R_{ISET} for a typical charge current is shown in Table 4.

Table 4: Charge Current Setting Table

R _{ISET} (kΩ)	Charge Current (A)		
215	1.0		
143	1.5		
107	2.0		
84.5	2.5		

Setting the Input Voltage Regulation in Charge Mode

In charge mode, connect a resistor divider from VL to AGND tapped to VLIM to program the input voltage regulation using Equation (20):

$$V_{INLMT} = 1.2V \times \frac{R3 + R4}{R4}(V)$$
 (20)

With the given R4, R3 can be calculated with Equation (21):

$$R3 = \frac{V_{INLMT} - 1.2V}{1.2V} \times R4(V)$$
 (21)

 V_{VLIM} is 1.2V. For a preset input voltage regulation value (i.e.: 4.675V), start with R4 = $10k\Omega$ and R3 = $27.4k\Omega$.

Setting the Output Current Limit in Discharge Mode

In discharge mode, connect a resistor from OLIM to AGND to program the output current limit. The relationship between the output current limit and setting resistor is shown in Equation (22):

$$I_{\text{OLIM}} = \frac{640(k\Omega)}{3 \times R_{\text{OLIM}}}(A)$$
 (22)

The output current limit of the boost can be programmed up to 5.0A.

The expected R_{OLIM} for typical output current limits is shown in Table 5.

Table 5: Discharge Current Setting Table

R _{OLIM} (kΩ)	Charge Current (A)		
215	1.0		
143	1.5		
107	2.0		
84.5	2.5		

Setting the Output Voltage in Discharge Mode

The MP2639C can regulate the output voltage on VL during discharge mode by adding voltage compensation to V_{LOAD} , which is the voltage powering the load. The setting formula for V_{LOAD} is shown in Equation (23):

$$V_{LOAD} = 1.2V \times \frac{R1 + R2}{R2}(V)$$
 (23)

The IC implements internal line drop compensation by feeding the output current to the top feedback resistance (R1). The selection of R1 must satisfy Equation (24):

$$R1 = \frac{R_{TRACE} \times R_{x}}{K_{SNS}}$$
 (24)

Where R_X is 150k Ω , K_{SNS} is 0.3, and R_{TRACE} is the line resistance of the trace from the output of the IC to the load of the system.

According to different evaluations on R_{TRACE} , choose an R1 value for correct compensation using Table 6. Suppose V_{LOAD} is required to regulate at 5V.

Table	6.	R1	R2	Sala	ction	Table
Iabie	ο.	r I.	74	JUIL	ะเนบท	Iabie

R _{TRACE} (Ω)	R1 (Ω)	R2 (Ω)
20m	10k	3.16k
50m	15k	4.75k
100m	50k	15.8k
150m	75k	23.7k
200m	100k	31.6k

Note that since the maximum sink current in FB pin is $4\mu A$, which means that the compensated output voltage of the IC is a maximum of $(4\mu A\times R1(k\Omega))$ higher than the voltage on the load side.

Resistor Selection for the NTC Sensor

Figure 16 shows an internal resistor divider reference circuit that limits both the high and low temperature thresholds at V_{HOT} and V_{COLD} , respectively. For a given NTC thermistor, select an appropriate R_{T1} and R_{T2} value to set the NTC window using Equation (25) and Equation (26):

$$\frac{\frac{R_{T2} \times R_{NTC_COLD}}{R_{T2} + R_{NTC_COLD}}}{R_{T1} + \frac{R_{T2} \times R_{NTC_COLD}}{R_{T2} + R_{NTC_COLD}}} = V_{COLD}$$
 (25)

$$\frac{\frac{R_{T2} \times R_{NTC_HOT}}{R_{T2} + R_{NTC_HOT}}}{R_{T1} + \frac{R_{T2} \times R_{NTC_HOT}}{R_{T2} + R_{NTC_HOT}}} = V_{HOT}$$
 (26)

Where $R_{\text{NTC_HOT}}$ is the value of the NTC resistor at a high temperature (within the required temperature operating range), and $R_{\text{NTC_COLD}}$ is the value of the NTC resistor at a low temperature.

The two resistors (R_{T1} and R_{T2}) allow the high and low temperature limits to be programmed independently. With this feature, the MP2639C can fit most types of NTC resistors and different temperature operating range requirements.

The R_{T1} and R_{T2} values depend on the type of NTC resistor selected.

For example, for a 103AT thermistor, $R_{\text{NTC_COLD}}$ is 27.28k Ω at 0°C, and $R_{\text{NTC_HOT}}$ is 3.02k Ω at 50°C.

The following equation calculations are derived assuming that the NTC window is between 0°C and 50°C. According to Equation (25) and

Equation (26), use V_{COLD} and V_{HOT} from the EC table to calculate R_{T1} = 2.27k Ω and R_{T2} = 6.86k Ω (see Figure 16).

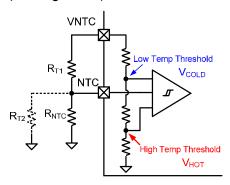


Figure 16: NTC Function Block

Selecting the Inductor

Inductor selection is a trade-off between cost, size, and efficiency. A lower inductance value corresponds with smaller size, but results in higher current ripple, higher magnetic hysteretic losses, and higher output capacitances. However, a higher inductance value benefits from lower ripple current and smaller output filter capacitors, but results in higher inductor DC resistance (DCR) loss.

Choose an inductor that does not saturate under the worst-case load condition.

When the MP2639C works in charge mode (as a boost converter), estimate the required inductance with Equation (27), Equation (28), and Equation (29):

$$L = \frac{V_{VL} \times (V_{VH} - V_{VL})}{V_{VH} \times f_{SW} \times \Delta I_{L MAX}}$$
(27)

$$\Delta I_{L MAX} = 30\% \times I_{VL(MAX)}$$
 (28)

$$I_{VL(MAX)} = \frac{V_{VH} \times I_{VH(MAX)}}{V_{VL} \times \eta}$$
 (29)

Where V_{VH} is the minimum battery voltage, f_{SW} is the switching frequency, ΔI_{L_MAX} is the peak-to-peak inductor ripple current (approximately 30% of the maximum input current ($I_{VL(MAX)}$)),

 $I_{VH(MAX)}$ is the battery current (2.5A), and η is the efficiency.

Under most application conditions, the charge current is limited at the input current limit, so $I_{VL(MAX)}$ is 3A, typically.

In the worst-case scenario with an 8.4V battery voltage, a 30% inductor current ripple, and a



typical input voltage (V_{VL} = 5V), the inductance is calculated as 1.9µH. When the MP2639C works in discharge mode (as a buck converter), estimate the required inductance with Equation (30):

$$L = \frac{V_{VH} - V_{VL}}{\Delta I_{L MAX}} \times \frac{V_{VL}}{V_{VH} \times f_{SW}}$$
 (30)

Where V_{VH} is the output voltage, V_{IN} is the input voltage, f_{SW} is the switching frequency, and ΔI_{L_MAX} is the maximum peak-to-peak inductor current (usually 30 - 40% of the discharge current).

With a typical 8.4V input voltage (2-cell battery), a 30% inductor current ripple at the max output current when V_{VL} is set at the typical 5V value (V_{VL} = 5V, $I_{VL(max)}$ = 5A), and the inductance is calculated as 1.2µH.

For best results, use an inductor with an inductance of 2.2µH with a DC current rating no lower than the peak current of the MOSFET. For higher efficiency, minimize the inductor's DC resistance.

Selecting the VL Capacitor (C_{VL})

Select the VL capacitor (C_{VL}) based on the demand of the system current ripple.

 C_{VL} is the input capacitor of the boost converter during charge mode and the output capacitor of the buck converter during discharge mode. Calculate its values with Equation (31) and Equation (32):

$$\Delta r_{VL} = \frac{\Delta V_{VL}}{V_{VL}} = \frac{1 - V_{VL} / V_{VH}}{8 \times C_{VL} \times f_{SW}^2 \times L}$$
(31)

$$C_{VL} = \frac{1 - V_{VL} / V_{VH_MAX}}{8 \times \Delta r_{VI_MAX} \times f_{SW}^2 \times L}$$
(32)

Suppose that the maximum VL ripple must not exceed 1% (e.g.: 0.5%). When V_{VH_MAX} is 8.4V, V_{VL} is 5V, L is 2.2 μ H, f_{SW} is 1200kHz, and Δr_{VL} ax is 0.5%, then C_{VL} is 3.2 μ F.

One 4.7µF ceramic capacitor with X7R dielectrics is sufficient.

Selecting the VH Capacitor (C_{VH})

The 2-cell battery is connected to the VH port, which is the output of the boost during charge mode and the input of the buck converter during

discharge mode.

In discharge mode, the capacitor C_{VH} acts as the input capacitor of the buck converter. The input current ripple can be calculated with Equation (33):

$$I_{\text{RMS_MAX}} = I_{\text{VH_MAX}} \times \frac{\sqrt{V_{\text{VL}} \times (V_{\text{VH_MAX}} - V_{\text{VL}})}}{V_{\text{VH_MAX}}} \quad (33)$$

In boost mode, the capacitor (C_{VH}) is the output capacitor of the boost converter. C_{VH} keeps the VH ripple small (<0.5%) and ensures feedback loop stability. The VH current ripple is given by Equation (29).

When I_{VH_MAX} is 2.0A, V_{VL} is 5V, and V_{VH_MAX} is 8.4V, the maximum ripple current is 1A. Select the system capacitors base on the ripple-current temperature rise, not to exceed 10°C. For best results, use X7R dielectric ceramic capacitors with low ESR and small temperature coefficients. For most applications, place two 22 μ F capacitors and one 1 μ F capacitor as close to the IC as possible.

PCB LAYOUT GUIDELINES

Efficient PCB layout is critical for meeting specified noise, efficiency, and stability requirements. For best results, follow the guidelines below.

- 1. Route the power stage adjacent to their grounds.
- Minimize the length of high-side switching node (SW, inductor) trace that carries the high current.
- Keep the switching node short and away from all control signals, especially the feedback network.
- 4. Place the input capacitor as close to VH and PGND as possible.
- Place the local power input capacitors connected from VL to PGND as close to the IC as possible.
- 6. Place the output inductor close to the IC.
- 7. Connect the output capacitor between the inductor and PGND of the IC.





- 8. Connect the power pads for VH, VL, BATT, and PGND to as many copper planes on the board possible for high-current as applications.
 - This improves thermal performance because the board conducts heat away from the IC.
- 9. Provide a ground plane for the PCB connected directly to the return of all components through vias (e.g.: two vias per capacitor for power-stage capacitors, one

- per capacitor for small-signal via components).
- A star ground design approach is typically used to keep circuit block currents isolated (power signal/control signal), which reduces noise coupling and ground bounce issues. A single ground plane for this design gives good results.
- 10. Place the ISET, OLIM and ILIM resistors very close to their respective IC pins.



TYPICAL APPLICATION CIRCUITS

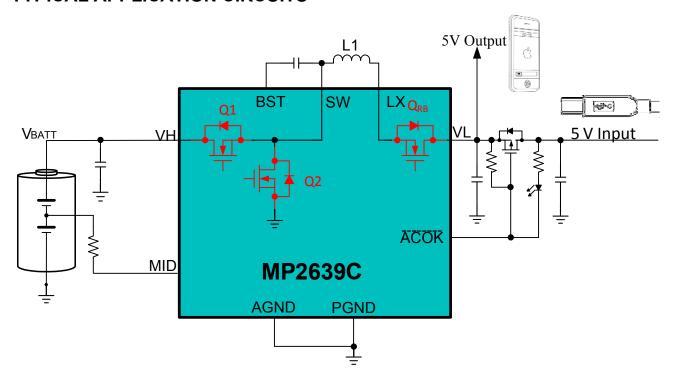


Figure 17: Two-Port Application

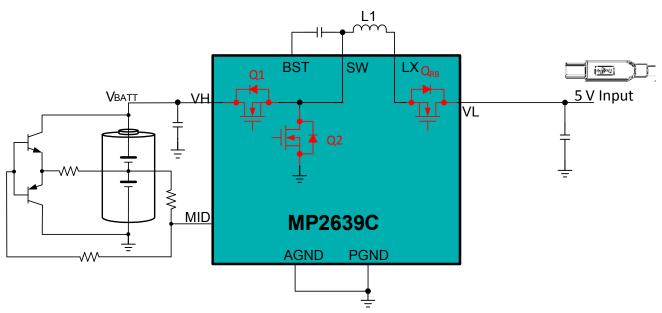
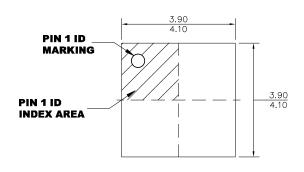


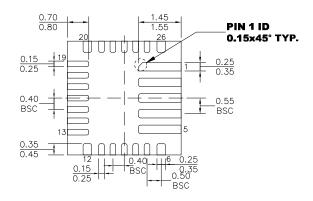
Figure 18: Large Balance Current Application



PACKAGE INFORMATION

QFN-26 (4mmx4mm)



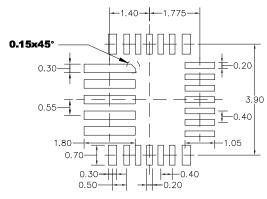


TOP VIEW

BOTTOM VIEW



SIDE VIEW



RECOMMENDED LAND PATTERN

NOTE:

- 1) ALL DIMENSIONS ARE IN MILLIMETERS.
- 2) LEAD COPLANARITY SHALL BE 0.10 **MILLIMETERS MAX.**
- 3) DRAWING CONFORMS TO JEDEC MO-220.
- 4) DRAWING IS NOT TO SCALE.

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